

1A PWM/VFM Step-down DC/DC Converter with Synchronous Rectifier Evaluation Board

No. EEV-362-Z001D018-250514

RP509Z001D018-EV is the evaluation board for RP509 which has the below features, benefits and specifications.

OUTLINE

The RP509Z is a low supply current PWM/VFM step-down DC/DC converter with synchronous rectifier featuring 0.5 A/1 A output current⁽¹⁾. Internally, a single converter consists of a reference voltage unit, an error amplifier, a switching control circuit, a mode control circuit, a soft-start circuit, an undervoltage lockout (UVLO) circuit, a thermal shutdown circuit, and switching transistors. The RP509Z is employing synchronous rectification for improving the efficiency of rectification by replacing diodes with built-in switching transistors. Using synchronous rectification not only increases circuit performance but also allows a design to reduce parts count. Output voltage controlling method is selectable between a PWM/VFM auto-switching control type and a forced PWM control type, which further reduces noise than a normal PWM control under a light load, and these types can be set by the MODE pin. Output voltage type is selectable between an internally fixed output voltage type and an externally adjustable output voltage type. Protection circuits in the RP509Z is current limit circuit and thermal shutdown circuit. LX current limit value (Typ.) is selectable between 1.6 A and 1.0 A. The RP509Z is available in WLCSP-6-P6 which achieves high-density mounting on boards. Using capacitor of 0402-/1005-size (inch/mm) and inductor of 0603-/1608-size (inch/mm) as external parts help to save space for devices.

FEATURES

- Input Voltage Range (Maximum Rating) 2.3 V to 5.5 V (6.5 V)
- Output Voltage Range (Fixed Output Voltage Type) 0.6 V to 3.3 V, settable in 0.1 V steps
(Adjustable Output Voltage Type) 0.6 V to 5.5 V
- Output Voltage Accuracy (Fixed Output Voltage Type) $\pm 1.5\%$ ($V_{SET}^{(2)} \geq 1.2$ V), ± 18 mV ($V_{SET} < 1.2$ V)
- Feedback Voltage Accuracy (Adjustable Output Voltage Type) ± 9 mV ($V_{FB} = 0.6$ V)
- Output Voltage/Feedback Voltage Temperature Coefficient ± 100 ppm/ $^{\circ}$ C
- Selectable Oscillator Frequency Typ. 6.0 MHz
- Oscillator Maximum Duty Min. 100%
- Built-in Driver ON Resistance ($V_{IN} = 3.6$ V) Typ. Pch. 0.175 Ω , Nch. 0.155 Ω (RP509Z)
- Standby Current Typ. 0 μ A
- UVLO Detector Threshold Typ. 2.0 V

⁽¹⁾ This is an approximate value. The output current is dependent on conditions and external components.

⁽²⁾ V_{SET} = Set Output Voltage

- Soft-start Time Typ. 0.15 ms
- Inductor Current Limit Circuit..... Typ. 1.6 A/1.0 A, selectable Current Limit
- Package WLCSP-6-P6 (1.28 mm x 0.88 mm x 0.64 mm)
- For more details on RP509 IC, please refer to
<https://www.n-redc.co.jp/en/pdf/datasheet/rp509-ea.pdf>.

Part Number Information

Product Name	Package
RP509Z001D018	WLCSP-6-P6

00: Adjustable Output Voltage Type

1: Specify the LX Current Limit (I_{LXLIM})

1: Typ.1.6 A

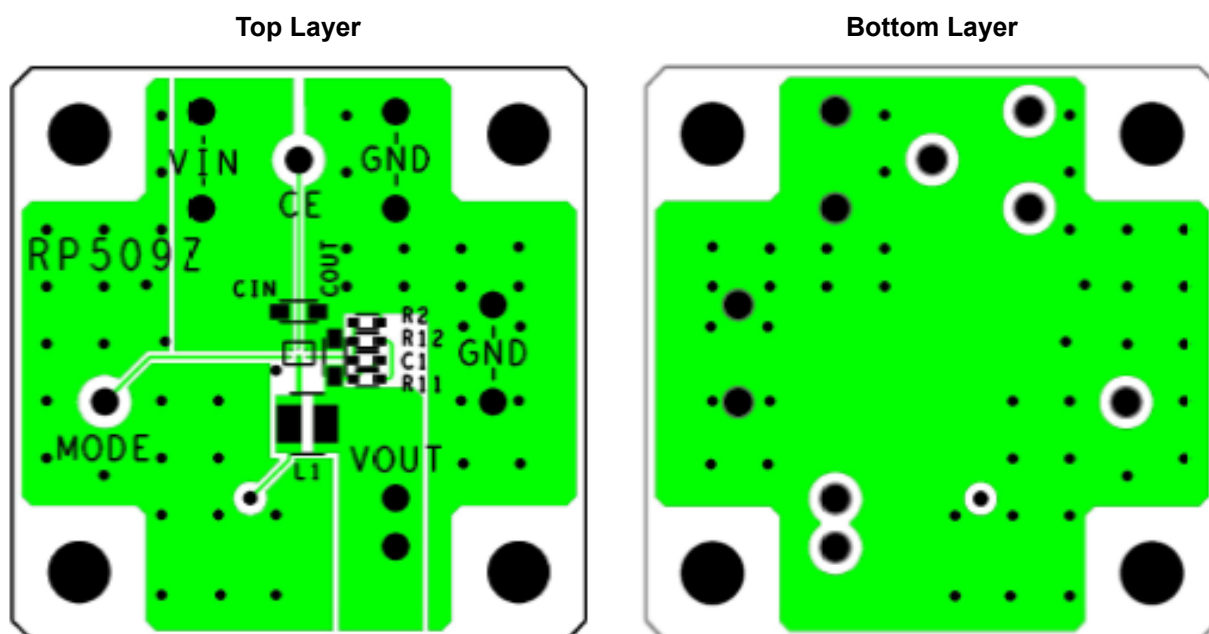
D: Specify the version

D: with Auto-discharge

018: 1.8 V, Output Voltage

PCB LAYOUT

Adjustable Output Voltage Type (RP509Z00XC/D)



ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings

(GND = 0 V)

Symbol	Item			Rating	Unit
V_{IN}	Input Voltage			-0.3 to 6.5	V
V_{LX}	LX Pin Voltage			-0.3 to $V_{IN} + 0.3$	V
V_{CE}	CE Pin Voltage			-0.3 to 6.5	V
V_{MODE}	MODE Pin Voltage			-0.3 to 6.5	V
V_{OUT}/V_{FB}	VOUT/VFB Pin Voltage			-0.3 to 6.5	V
I_{LX}	LX Pin Output Current			1.6	A
P_D	Power Dissipation ⁽¹⁾	WLCSP-6-P6	JEDEC STD. 51-9 Test Land Pattern	910	mW
T_j	Junction Temperature			-40 to 125	°C
Tstg	Storage Temperature Range			-55 to 125	°C

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	2.3 to 5.5	V
T_a	Operating Temperature Range	-40 to 85	°C

RECOMMENDED OPERATING CONDITIONS

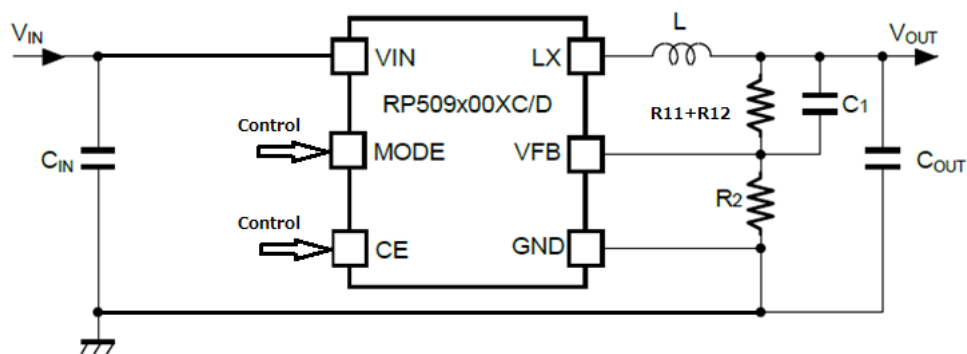
All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

⁽¹⁾ Refer to *POWER DISSIPATION* for detailed information.

APPLICATION INFORMATION

Typical Application Circuits

MODE = High: Forced PWM Control, MODE = Low: PWM/VFM Auto-switching Control



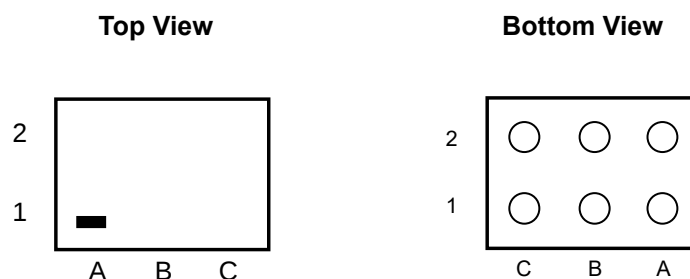
RP509x00XC/RP509x00XD (Adjustable Output Voltage Type)

Recommended External Components^{*1}

Symbol	Size
C _{IN}	10 μF
C _{OUT}	10 μF
L	0.47 μH
R11	220 kΩ
R12	220 kΩ
R2	220 kΩ
C1	33 pF

^{*1} The bill of materials will be attached on the shipment of each purchased evaluation board.

PIN DESCRIPTION



WLCSP-6-P6 Pin Configurations

WLCSP-6-P6 Pin Description

Pin No.	Symbol	Description
A1	MODE	Mode Control Pin (High: Forced PWM Control, Low: PWM/VFM Auto-switching Control)
B1	LX	Switching Pin
C1	VOUT/VFB	Output/Feedback Voltage Pin
A2	VIN	Input Voltage Pin
B2	CE	Chip Enable Pin, Active-high
C2	GND	Ground Pin

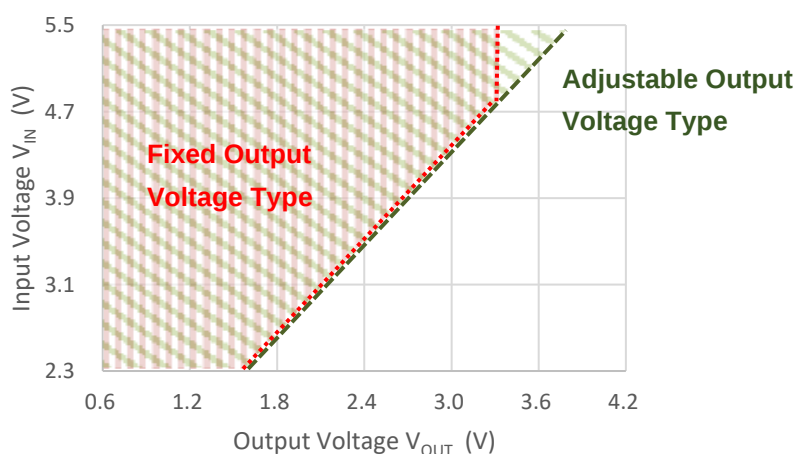
TECHNICAL NOTES

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed its rated voltage, rated current or rated power. When designing a peripheral circuit, please be fully aware of the following points.

- Set the external components as close as possible to the IC and minimize the wiring between the components and the IC. Especially, place a capacitor (C_{IN}) as close as possible to the VIN pin and GND.
- Ensure the VIN and GND lines are sufficiently robust. If their impedance is too high, noise pickup or unstable operation may result.
- The VIN line, the GND line, the VOUT line, an inductor, and LX should make special considerations for the large switching current flows.
- The wiring between the VOUT pin and an inductor (L) (RP509xxxXA/RP509xxxXB) should be separated from the wiring between L and Load.
- Over current protection circuit may be affected by self-heating or power dissipation environment.
- For any setting type of output voltage, the input/output voltage ratio must meet the following requirement to achieve a stable VFM mode at light load when the MODE pin is “Low” (at PWM/VFM Auto Switching):

$$V_{OUT} / V_{IN} < 0.7$$

$V_{MODE} = \text{Low}$, PWM/VFM Auto Switching



Available Voltage Area with Stable VFM Mode

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6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. Anti-radiation design is not implemented in the products described in this document.
8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.
11. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



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